| © C | terial Compositi opyright 2005. IPC, E rnational and Pan-Am | Bannockbu | ırn, Illinois. A | ll rights reserved untions. | under both | This docume level parts, th | ent is a decla he declaratio | ration of n encom | the substance passes all low | es within the ver level ma | e manufactur terials for w | rer listed it hich the m | em. Not anufacti | te: if the it urer has ei | em is an ass ngineering r | sembly with lowe esponsibility. |
|--|---|------------|---------------------------|-----------------------------|-------------------------|--|---------------------------------|-----------------------------|------------------------------|-------------------------------|---------------------------------|---------------------------------|---------------------|------------------------------|------------------------------|------------------------------------|
| | IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Dist | | | | Form Type Distribute | orm Type * Declaration Class * stribute Class 6 - RoHS Yes/No, Homogeneous Mai | | | | | eous Materi | rials and Mfg Information | | | | |
| Supplier Information | l | | | | | | | | | | | | | | | |
| Company name* | | | Company unique ID | | | Unique ID Authority | | | | | Response Date* | | | | | |
| onsemi | | | | | | | | | | | | 2024-05-09 | | | | |
| Contact Name | | | Title - Contact | | |] | Phone - Contact* | | | | | Email - Contact* | | | | |
| Product-Env-Stewards | | | Product Enviro Compliance | | | | NA | | | | | Product-Env-Stewards@onsemi.com | | | | |
| Authorized Representative* | | | Title - Representative | | | Phone - Representative* | | | | Email - Representative* | | | | | | |
| Product-Env-Stewards | | | Product Enviro Compliance | | | | NA | | | | Product-Env-Stewards@onsemi.com | | | | | |
| Requester Item | Requester Item Number Mfr Item Numb NCP5623CMU | | m Number Mfr Item Name | | | | | ective Date Version | | Manufacturing Site | | V | Veight* | Ľ | JOM | Unit Type |
| | | | CMUTBG | BG RGB LED DRIVER WITH I2C | | | 2024-05-09 MY1 | | MY1 | .Y1 | | .43 | n | ng | Each | |
| Manufacturing Proce | cess Information | | | | | | | | | 1 | | I | | | | |
| Terminal Plating | Terminal Plating / Grid Array Material | | Cerminal Base Alloy J-S | | J-STD-020 MS | MSL Rating | | Peak Process Body Temperatu | | ure Max Time at Peak Tem | | Temperat | ire Nu | umber of H | Reflow Cycl | les |
| Precious metal (e.g. Ag,Au, NiPdAu) (no Sn) | |) (no CU | CU Alloy 1 | | 1 | | 260 | | С | 30 | | second | ls 3 | | | |
| Comments | | | | | | | | | | | | | | | | |
| evel 1 - maximum time at | peak temperature du | uring sold | lering is 10-3 | 0 seconds | | | | | | | | | | | | |
| or more information rega | arding material com | position p | lease refer to | page 3 | | | | | | | | | | | | |

| RoHS Material Composition Declaration | | | | Declaration Type * | Detailed |
|--|--|--|---|---|---|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | | nium (Cr6+), Polybro | ominated Biphenyls (PBB), Polybron | dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth | |
| cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the | henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies | RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform | ce of its products with European Union membe | ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of |
| RoHS Declaration * 1 - Item(s) | does not contain RoHS restricted substa | on above | Supplier Acceptance | * Accepted | |
| Exemption: If the declared item does not con applicable exemptions. | ntain RoHS restricted substances per | the definition above | except for defined RoHS exempti | ons, then select the corresponding response i | n the RoHS Declaration above and choose all |
| Exemption List Version | EL-2011/534/EU | | | | |
| Declaration Signature | | | | | |
| Instructions: Complete all of the required fin Requester) and click on Submit Form to have | elds on all pages of this form. Select the form returned to the Requester | he "Accepted" on th | e Supplier Acceptance drop-down | . This will display the signature area. Digital | lly sign the declaration (if required by the |
| Supplier Digital Signature Ra | stislav Drska | Le | | | |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|---------------------------|------------------|--------|--------|-----------------|
| Die | 0.05 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.05 | mg |
| Die Attach | 0.05 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.0425 | mg |
| | | | Supplier | Epoxy resins | 129915-35-1 | | 0.0075 | mg |
| Mold Compound-Black | 4.92 | mg | | Epoxy resin | proprietary data | | 0.2952 | mg |
| | | | Supplier | Phenolic Resin | Proprietary Data | | 0.2952 | mg |
| | | | Supplier | Carbon Black (C) | 1333-86-4 | | 0.0246 | mg |
| | | | Supplier | Fused Silica (SiO2) | 60676-86-0 | | 4.182 | mg |
| | | | Supplier | Silica Crystalline (SiO2) | 14808-60-7 | | 0.123 | mg |
| Plating | 0.32 | mg | Supplier | Palladium (Pd) | 7440-05-3 | | 0.0243 | mg |
| | | | В | Nickel (Ni) | 7440-02-0 | | 0.2912 | mg |
| | | | Supplier | Gold (Au) | 7440-57-5 | | 0.0045 | mg |
| Wire Bond - Au | 0.09 | mg | Supplier | Gold (Au) | 7440-57-5 | | 0.09 | mg |